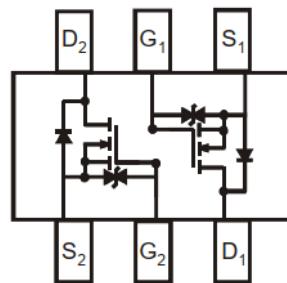


### Features

- Low on-resistance
- High-speed switching
- Drive circuits can be simple
- Parallel use is easy
- JESD22-A114-B: 2

**HF**

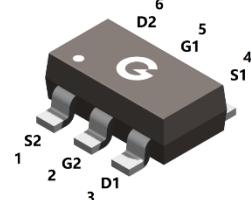


### Typical Applications

- N-channel enhancement mode effect transistor
- Switching application

### Mechanical Data

- Case: SOT-23-6L
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208



**SOT-23-6L**

### Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
BSS5003-6L	SOT-23-6L	3000 pcs / Tape & Reel	5003

### Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{DSS}$	50	V
Gate-to-Source Voltage	$V_{GSS}$	$\pm 20$	V
Continuous Drain Current <sup>*1</sup>	$I_D$	310	mA
Pulsed Drain Current ( $t_p = 10\mu\text{s}$ )	$I_{DM}$	2000	mA
Power Dissipation ( $T_A = 25^\circ\text{C}$ ) <sup>*1</sup>	$P_D$	0.4	W
Operating Junction Temperature Range	$T_J$	-55 ~ +150	°C
Storage Temperature Range	$T_{STG}$	-55 ~ +150	°C

### Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance Junction to Ambient Air <sup>*1</sup>	$R_{\theta JA}$	-	-	310	°C/W

**Electrical Characteristics** (@  $T_A = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Test conditions	MIN	TYP	MAX	UNIT
<b>OFF Characteristics</b>						
$V_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu\text{A}$	50	-	-	V
$I_{DS(on)}$	Drain to Source Leakage Current	$V_{DS} = 50V, V_{GS} = 0V$	-	-	1	$\mu\text{A}$
$I_{GSS}$	Gate-body Leakage	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	$\pm 10$	$\mu\text{A}$
<b>ON Characteristics</b>						
$R_{DS(on)}$	Drain-Source On-resistance <sup>*2</sup>	$V_{GS} = 10V, I_D = 0.5A$	-	1.1	1.5	$\Omega$
		$V_{GS} = 4.5V, I_D = 0.2A$	-	1.2	2.5	
		$V_{GS} = 2.5V, I_D = 0.2A$	-	1.6	2.9	
		$V_{GS} = 1.8V, I_D = 0.05A$	-	2.8	4.0	
$V_{GS(\text{TH})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.5	0.8	1.0	V
$R_G$	Gate Resistance	$V_{GS} = 0V, f = 1\text{MHz}$	-	34	-	$\Omega$
<b>Dynamic Characteristics</b>						
$C_{ISS}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 20V$ $f = 1.0\text{MHz}$	-	44	-	$\text{pF}$
$C_{OSS}$	Output Capacitance		-	10	-	
$C_{RSS}$	Reverse Transfer Capacitance		-	7	-	
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-on Delay Time <sup>*3</sup>	$V_{DD} = 30V, I_D = 0.2A$ $V_{GS} = 10V, R_G = 25\Omega$ $R_L = 150\Omega$	-	6	-	$\text{nS}$
$t_r$	Turn-on Rise Time <sup>*3</sup>		-	5	-	
$t_{d(off)}$	Turn-Off Delay Time <sup>*3</sup>		-	25	-	
$t_f$	Turn-Off Fall Time <sup>*3</sup>		-	15	-	
$Q_G$	Total Gate-Charge	$V_{DD} = 25V$ $V_{GS} = 10V$ $I_D = 0.2A$	-	4.3	-	$\text{nC}$
$Q_{GS}$	Gate to Source Charge		-	0.7	-	
$Q_{GD}$	Gate to Drain (Miller) Charge		-	0.5	-	
<b>Source-Drain Diode Characteristics</b>						
$V_{SD}$	Diode Forward Voltage <sup>*2</sup>	$I_S = 0.3A, V_{GS} = 0V$	-	0.85	1.2	V

Notes:

1. The data tested by surface mounted on a FR-4 board
2. The data tested by pulsed, pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$
3. Guaranteed by design, not subject to production

### Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

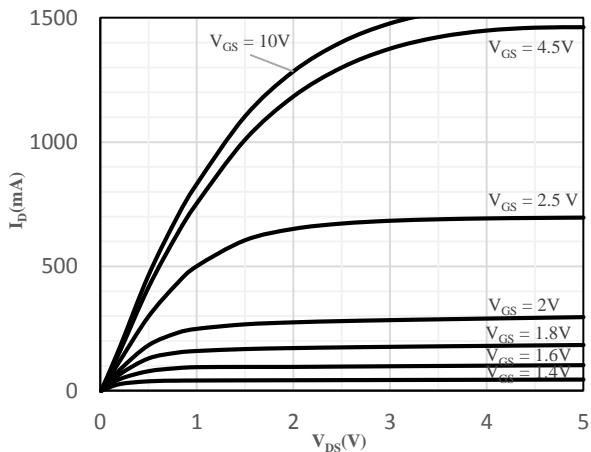


Fig 1 Typical Output Characteristics

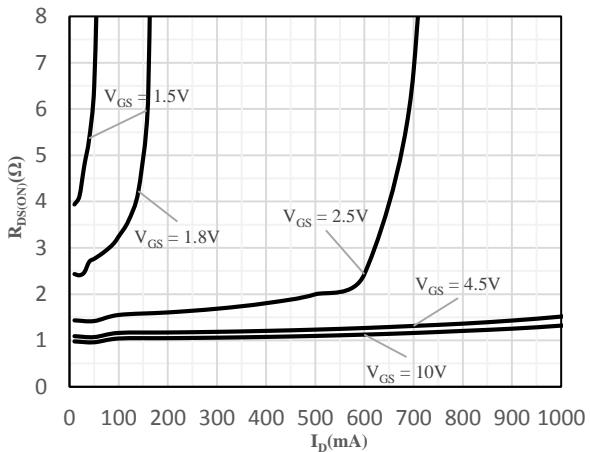


Fig 2 On-Resistance vs. Drain Current  
and Gate Voltage

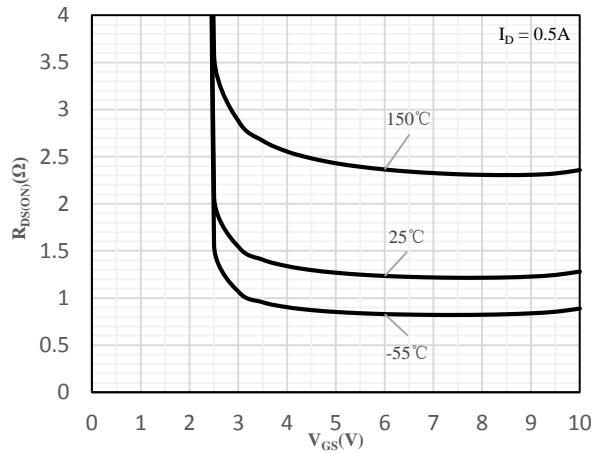


Fig 3 On-Resistance vs. Gate-Source Voltage

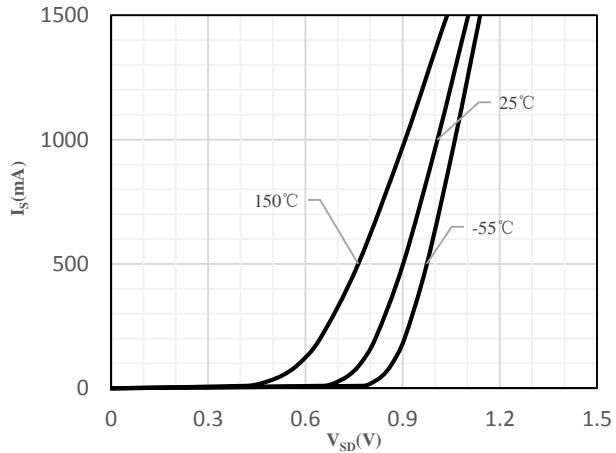


Fig 4 Body-Diode Characteristics

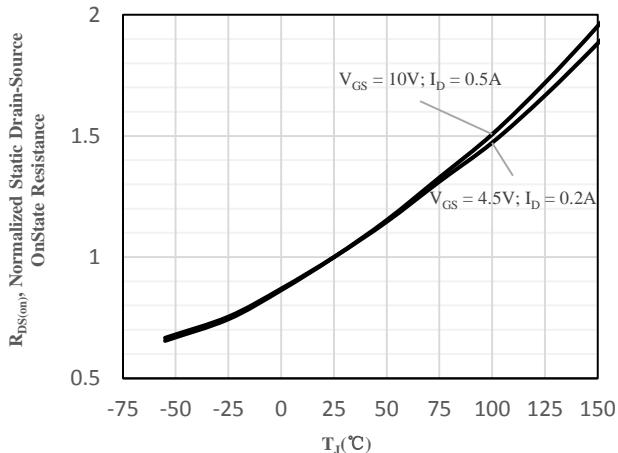


Fig 5 Normalized On-Resistance vs. Junction  
Temperature

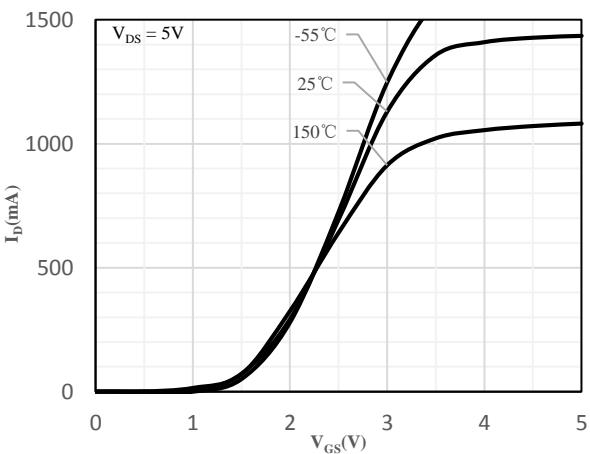


Fig 6 Transfer Characteristics

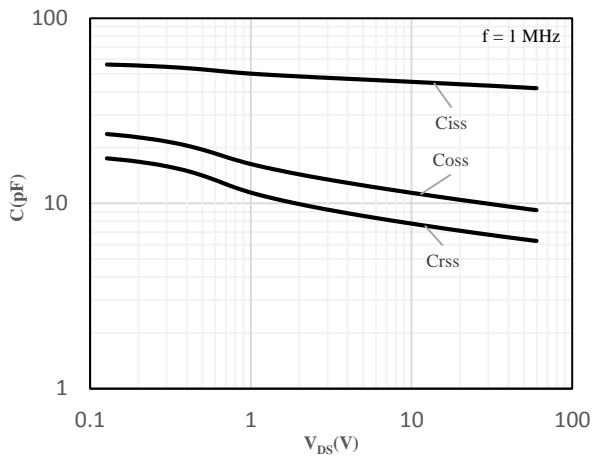


Fig 7 Capacitance Characteristics

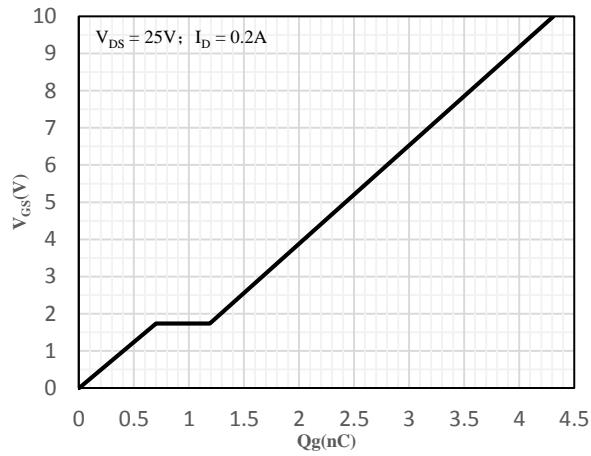


Fig 8 Gate-Charge Characteristics

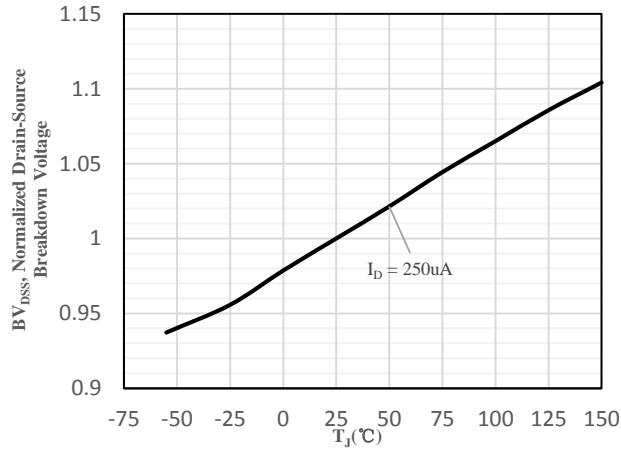


Fig 9 Normalized Breakdown Voltage  
vs. Junction Temperature

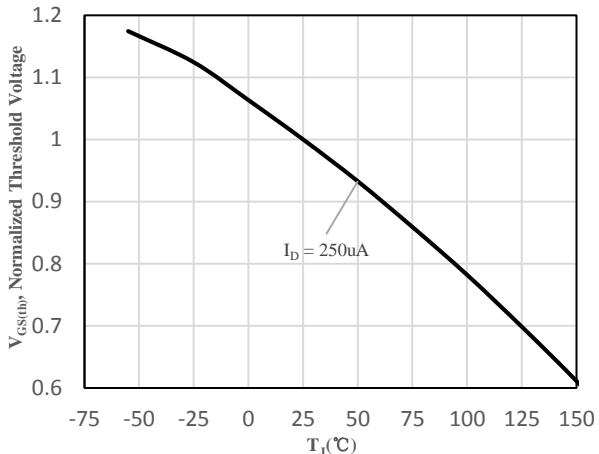


Fig 10 Normalized  $V_{GS(th)}$  vs. Junction Temperature

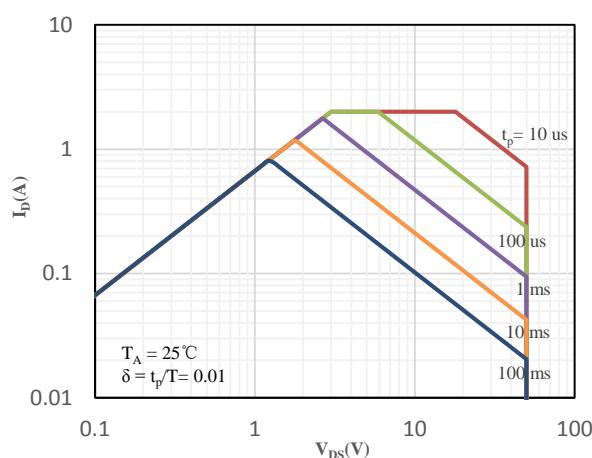


Fig 11 Safe Operation Area

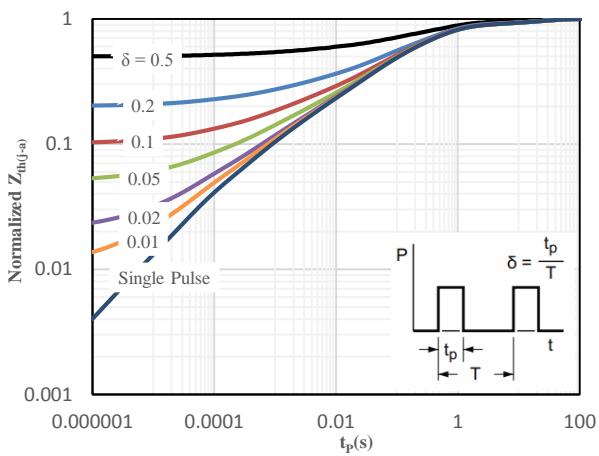
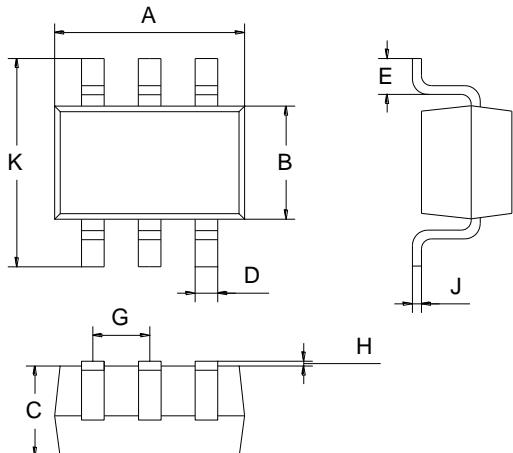


Fig 12 Normalized Maximum transient thermal  
impedance

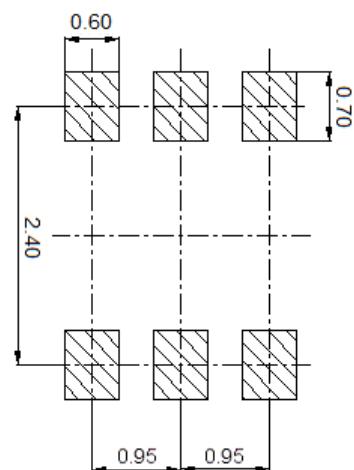
### Package Outline Dimensions (Unit: mm)



SOT-23-6L		
Dimension	Min.	Max.
A	2.80	3.00
B	1.50	1.70
C	1.00	1.20
D	0.35	0.45
E	0.35	0.55
G	0.90	1.00
H	0.02	0.10
J	0.10	0.20
K	2.60	3.00

### Mounting Pad Layout (Unit: mm)

#### SOT-23-6L



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